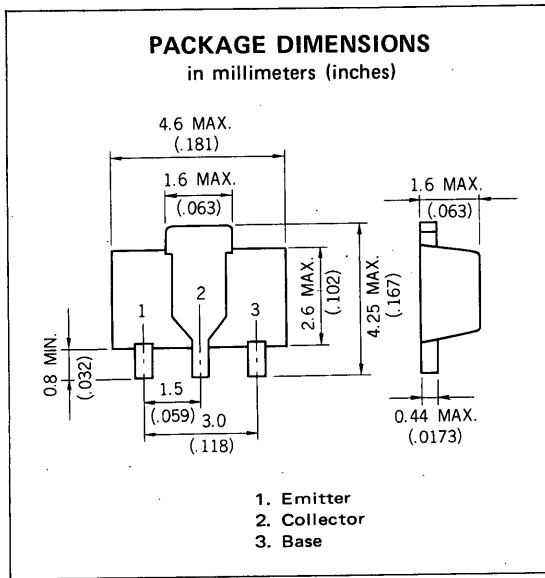


**PNP SILICON EPITAXIAL TRANSISTOR
POWER MINI MOLD**

DESCRIPTION

The 2SB804 is designed for audio frequency power amplifier application, especially in Hybrid Integrated Circuits.



FEATURES

- World Standard Miniature Package : SOT-89
- High Collector to Base Voltage : $V_{CBO} > -100$ V
- Excellent DC Current Gain Linearity : $h_{FE} = 80$ TYP. ($V_{CE} = -2.0$ V, $I_C = -500$ mA)
- Complements to NPN type 2SD1005

ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

Maximum Voltages and Currents

Collector to Base Voltage	V_{CBO}	-100	V
Collector to Emitter Voltage	V_{CEO}	-80	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current (DC)	I_C	-1.0	A
Collector Current (Pulse)*	I_C	-1.5	A

Maximum Power Dissipation

Total Power Dissipation at 25°C Ambient Temperature**	P_T	2.0	W
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Maximum Temperatures

Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$

*PW \leq 10 ms, duty cycle \leq 50 %

**When mounted on ceramic substrate of 16 cm² x 0.7 mm

ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

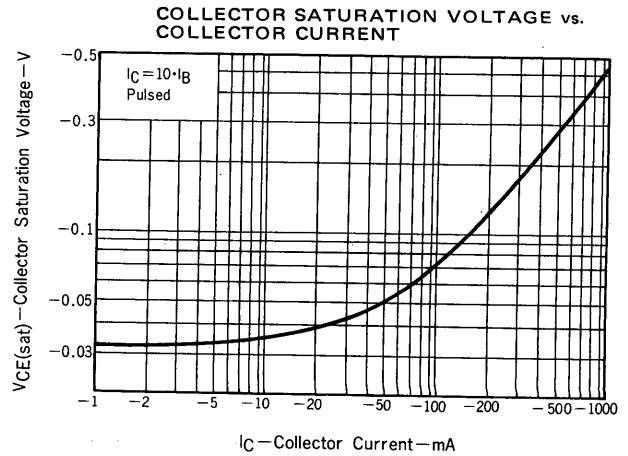
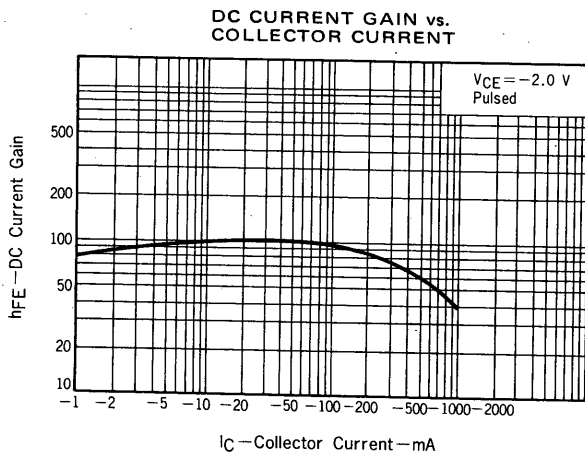
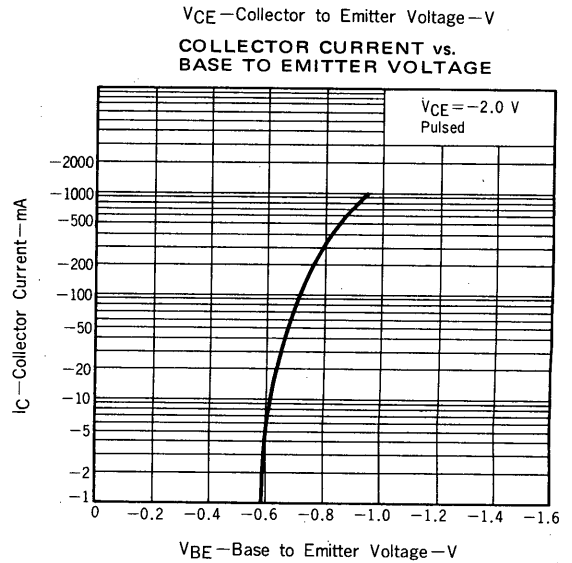
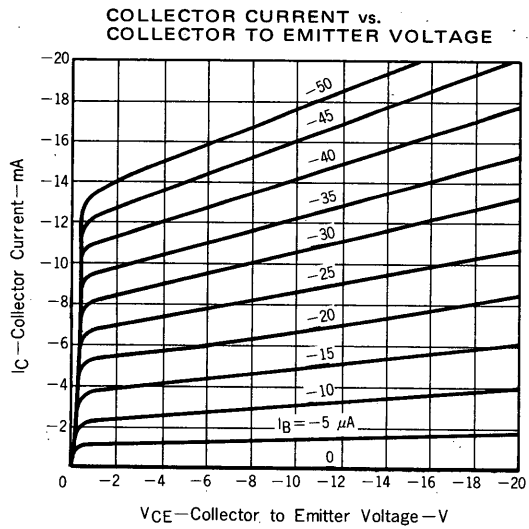
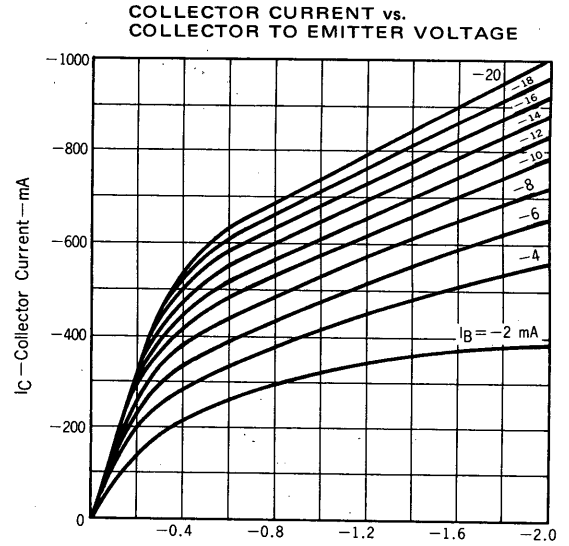
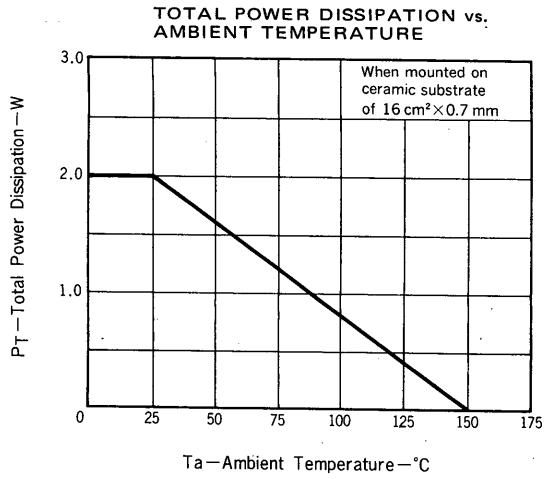
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	I_{CBO}			-100	nA	$V_{CB} = -100$ V, $I_E = 0$
Emitter Cutoff Current	I_{EBO}			-100	nA	$V_{EB} = -5.0$ V, $I_C = 0$
DC Current Gain	h_{FE1}	90	200	400		$V_{CE} = -2.0$ V, $I_C = -100$ mA ***
DC Current Gain	h_{FE2}	25	80			$V_{CE} = -2.0$ V, $I_C = -500$ mA ***
Collector Saturation Voltage	$V_{CE(sat)}$		-0.29	-0.50	V	$I_C = -500$ mA, $I_B = -50$ mA ***
Base Saturation Voltage	$V_{BE(sat)}$		-0.9	-1.5	V	$I_C = -500$ mA, $I_B = -50$ mA ***
Base to Emitter Voltage	V_{BE}	-600	-640	-700	mV	$V_{CE} = -10$ V, $I_C = -10$ mA ***
Gain Bandwidth Product	f_T		80		MHz	$V_{CE} = -5.0$ V, $I_E = 10$ mA
Output Capacitance	C_{ob}		26		pF	$V_{CB} = -10$ V, $I_E = 0$, $f = 1.0$ MHz

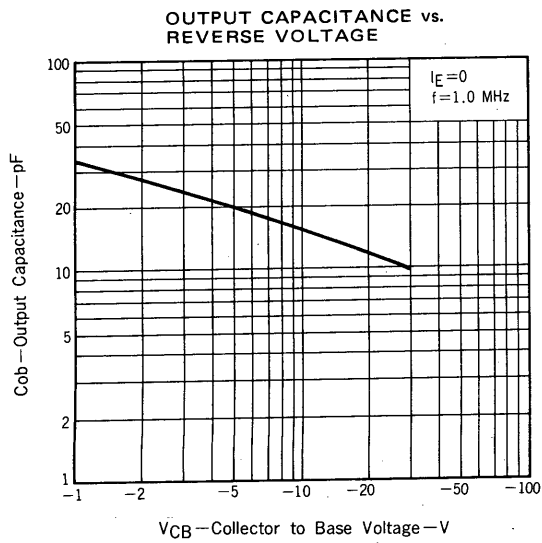
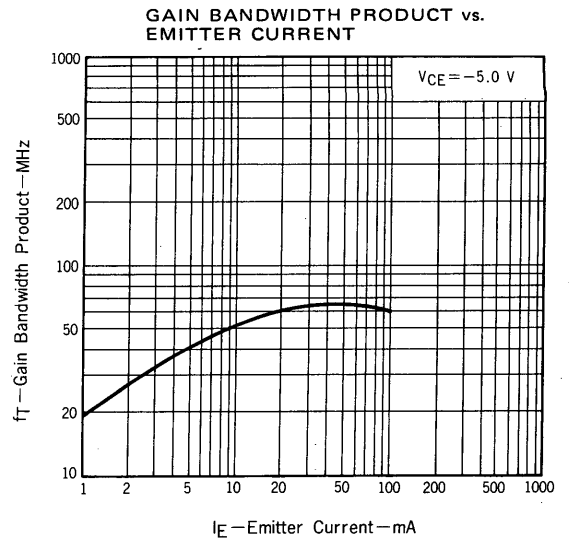
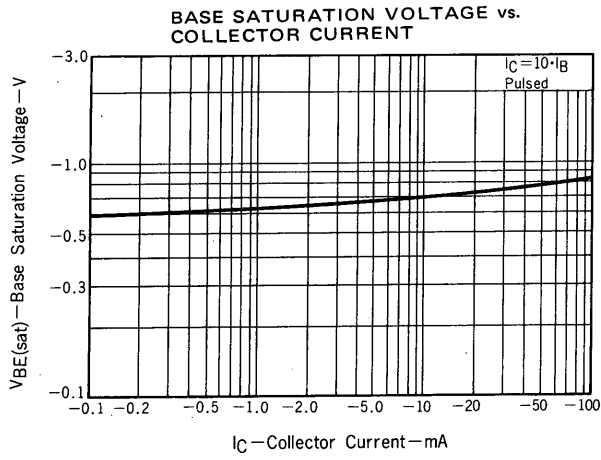
***Pulsed: PW \leq 350 μ s, duty cycle \leq 2 %

h_{FE} Classification

MARKING	AW	AV	AU
h_{FE1}	90 - 180	135 - 270	200 - 400

TYPICAL CHARACTERISTICS (Ta = 25 °C)





REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134

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